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N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (mΩ)(Typ.)	I _D (A) ^a (Max.)			
60	29 at V _{GS} = 10 V	25			
	36 at V _{GS} = 4.5 V	- 35			

TO-252 Pin Configuration

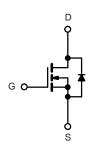
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Top View

- DT-Trench Power MOSFET
- 100% Rg and UIS Tested

APPLICATIONS

- Motor Drive
- Power Tools



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Gate-Source Voltage	V _{GS}	± 20	V			
Continuous Drain Current (T. 450 °C)	T _C = 25 °C	1	35			
Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^{b}$	T _C = 100 °C	I _D	25 ^a			
Pulsed Drain Current	I _{DM}	90	A			
Continuous Source Current (Diode Conduction)	۱ _S	35				
Avalanche Current	I _{AS}	30				
Single Avalanche Energy (Duty Cycle \leq 1 %)	E _{AS}	29	mJ			
Movimum Dougr Dissinction	T _C = 25 °C	Pn –	45	W		
Maximum Power Dissipation	T _A = 25 °C		2.3 ^{b, c}	vv		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum lunation to Ambianta	$t \le 10 \text{ sec}$	R _{thJA}	13	18	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		35	55		
Maximum Junction-to-Case		R _{thJC}	2.0	3.0		

Notes:

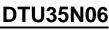
a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t \leq 10 s.







Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	60			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 48 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$			50	μA	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	35			А	
	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A	29 36		36	mΩ	
Drain-Source On-State Resistance ^b	VDS(on)	V _{GS} = 4.5 V, I _D = 10 A		36	46	11132	
Forward Transconductanceb	9 _{fs}	V _{DS} = 5 V, I _D = 20 A		40		S	
Dynamic							
Input Capacitance	C _{iss}			826		pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 30 V, f = 1 MHz		51			
Reverse Transfer Capacitance	C _{rss}			43			
Total Gate Charge ^c	Qg			20	30		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 30 V, V_{GS} = 10 V, I_{D} = 15 A		1.9		nC	
Gate-Drain Charge ^c	Q _{gd}			4.5		1	
Turn-On Delay Time ^c	t _{d(on)}			13			
Rise Time ^c	t _r	V_{DD} = 30 V, R _L = 1.0 Ω		46		~~~	
Turn-Off Delay Time ^c	t _{d(off)}	I_D =15 A, V_{GEN} = 10 V, R_g = 2.5 Ω		25		ns	
Fall Time ^c	t _f			10		1	
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C)					
Pulsed Current	I _{SM}				90	А	
Diode Forward Voltage	V _{SD}	I _F = 1 A, V _{GS} = 0 V		0.6	1.0	V	
Reverse Recovery Time	t _{rr}	I _F = 15 A, di/dt = 500 A/μs		25	50	ns	
Reverse Recovery Charge	Q _{rr}	I _F = 15 A, di/dt = 500 A/µs		45	100	nC	

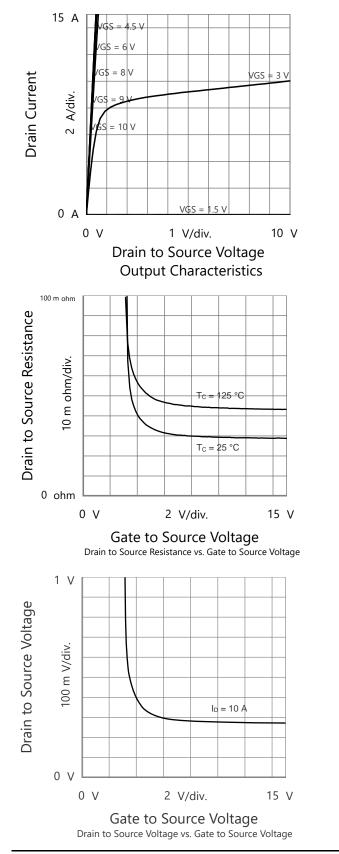
Notes:

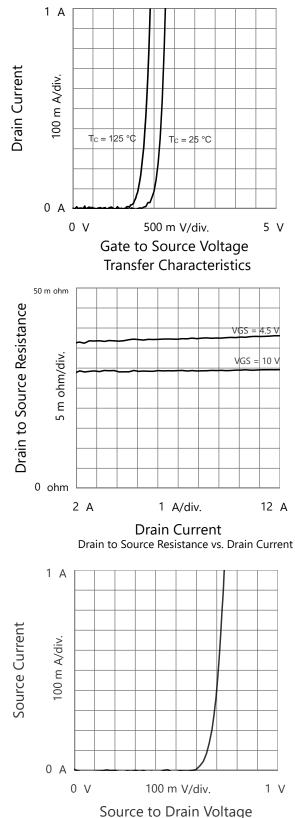
a. For design aid only; not subject to production testing. b. Pulse test; pulse width 300 $\mu s,$ duty cycle 2 %.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

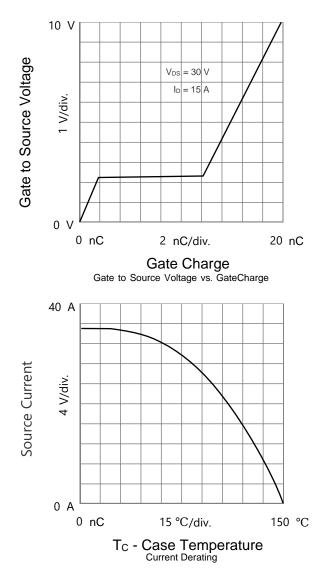
TYPICAL CHARACTERISTICS (25 °C unless noted)

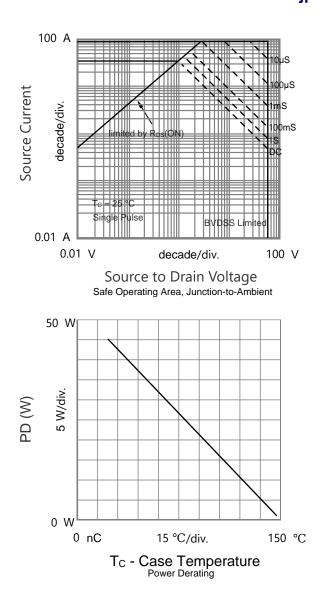




Body Diode Forward Characteristics

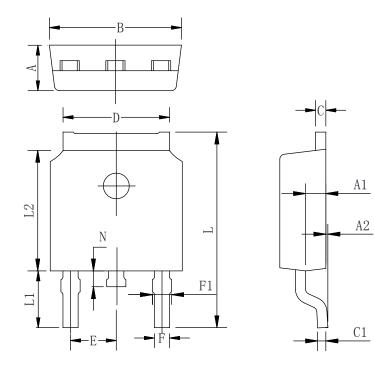
TYPICAL CHARACTERISTICS (25 °C unless noted)







TO-252-2L PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Тур	Max	
А	2.10	2.30	2.50	
A1	0.88	1.01	1.16	
A2	0.00	0.15	0.28	
В	6.40	6.60	6.80	
С	0.42	0.50	0.63	
C1	0.42	0.50	0.63	
D	5.08	5.32	5.65	
Е	2.286 TYP			
F	0.63	0.76	0.89	
F1	0.64	0.86	1.08	
L	9.30	9.90	10.80	
L1	2.4	2.8	3.6	
L2	5.90	6.10	6.55	
N	0.57	0.80	1.05	

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